

BAT750

SOT23 Schottky barrier diode

Summary

$V_R = 40V$

$I_F = 750mA$

$V_F < 490mV @ 750mA$



Description

A high current Schottky barrier diode in a small outline surface mount package for applications where space is limited.

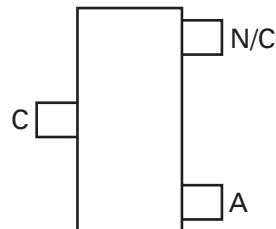


Features

- Low V_F
- High current capability
- SOT23 package

Applications

- DC-DC converters
- Mobile telecoms
- PCMIA



Ordering information

Top view

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
BAT750TA	7	8	3000

Device marking

1G1

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Collector reverse voltage	V_R	40	V
RMS reverse voltage	$V_{R(\text{RMS})}$	28	V
Forward current (continuous)	I_F	750	mA
Forward voltage @ $I_F = 750\text{mA}$	V_F	490	mV
Average peak forward current; DC = 50%	I_{FAV}	1500	mA
Non repetitive forward current $t \leq 100\mu\text{s}$ $t \leq 8.3\text{ms}$	I_{FSM}	12 5.5	A
Power dissipation @ $T_{\text{amb}} = 25^\circ\text{C}$	P_{tot}	350	mW
Typical thermal resistance, junction to ambient air	$R_{\Theta JA}$	286	°C/W
Storage temperature range	T_{stg}	-55 to +150	°C
Junction temperature	T_j	125	°C

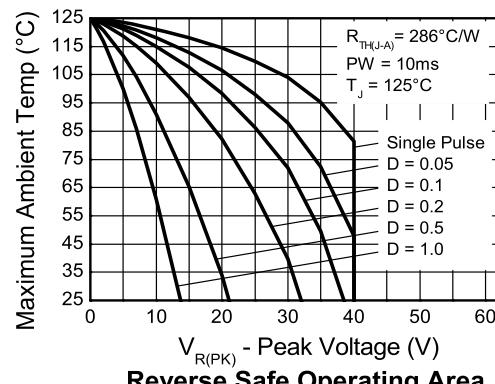
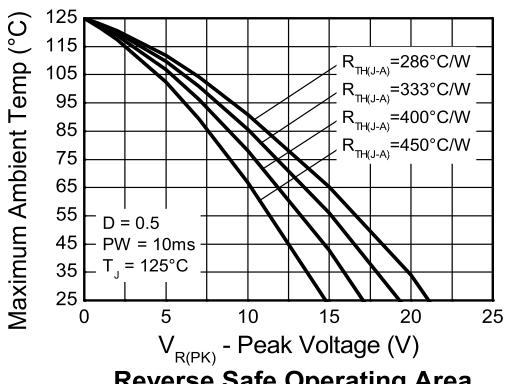
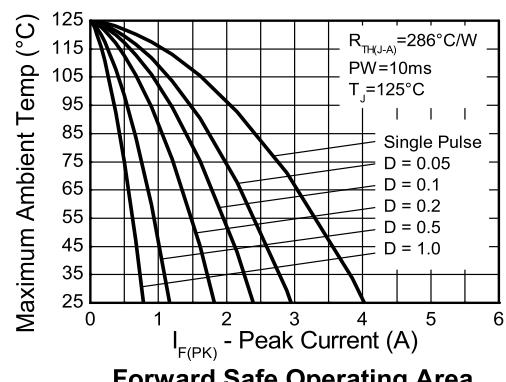
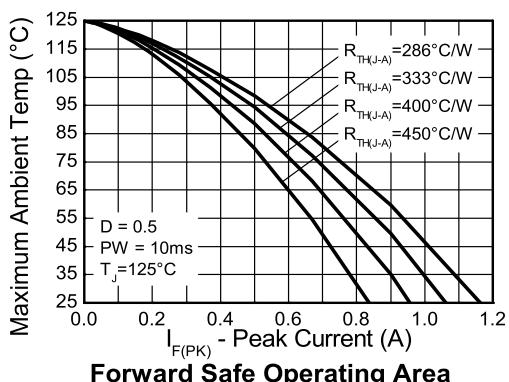
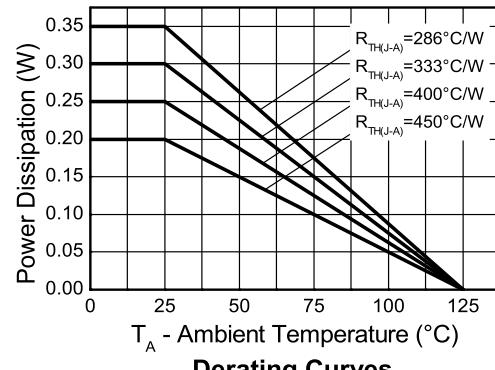
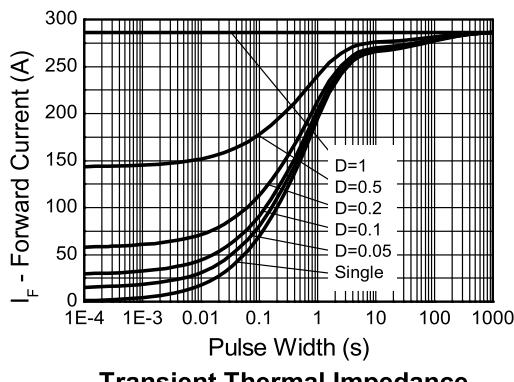
Electrical characteristics (@ $T_{\text{amb}} = 25^\circ\text{C}$ unless otherwise stated)

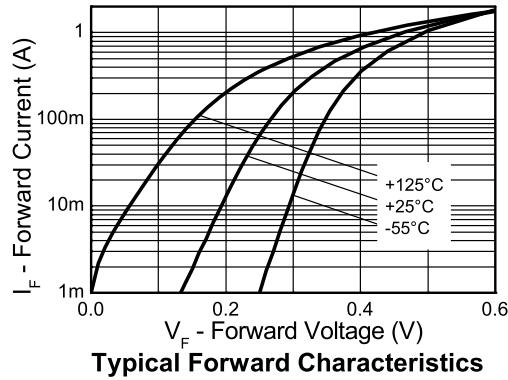
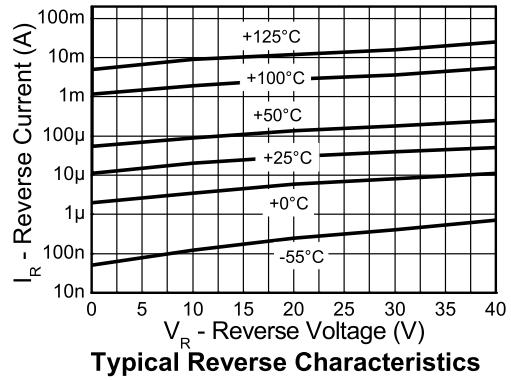
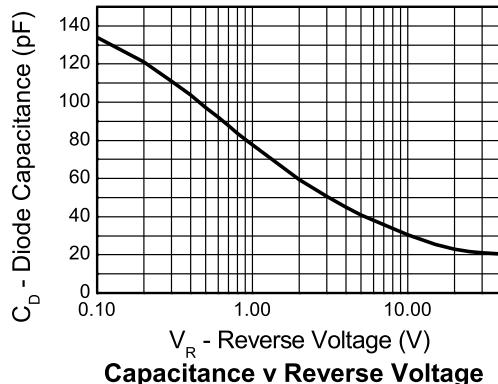
Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Reverse breakdown voltage	$V_{(\text{BR})R}$	40	60		V	$I_R = 300\mu\text{A}$
Forward voltage	V_F		225	280	mV	$I_F = 50\text{mA}$ (*)
			235	310	mV	$I_F = 100\text{mA}$ (*)
			290	350	mV	$I_F = 250\text{mA}$ (*)
			340	420	mV	$I_F = 500\text{mA}$ (*)
			390	490	mV	$I_F = 750\text{mA}$ (*)
			440	540	mV	$I_F = 1000\text{mA}$ (*)
			530	650	mV	$I_F = 1500\text{mA}$ (*)
Reverse current	I_R		50	100	μA	$V_R = 30\text{V}$
Diode capacitance	C_D		25	-	pF	$V_R = 25\text{V}$, $f = 1.0\text{MHz}$
Reverse recovery time	t_{rr}		5	-	ns	$I_F = I_R = 100\text{mA}$, $I_{rr} = 10\text{mA}$

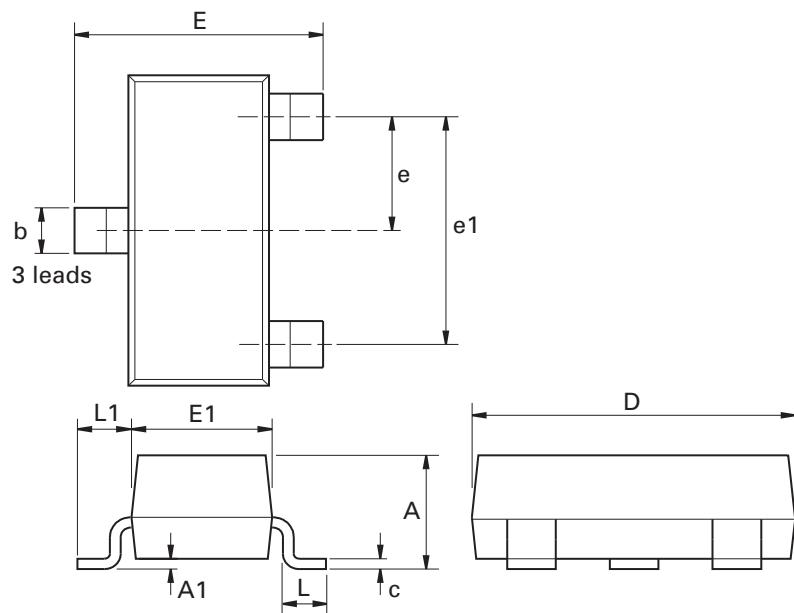
NOTES:

(*) Measured under pulsed conditions. Pulse width = $300\mu\text{s}$, duty cycle $\leq 2\%$.

Thermal data



Typical characteristics**Typical Forward Characteristics****Typical Reverse Characteristics****Capacitance v Reverse Voltage**

Package outline - SOT23

Dim.	Millimeters		Inches		Dim.	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Max.	Max.
A	-	1.12	-	0.044	e1	1.90 NOM		0.075 NOM	
A1	0.01	0.10	0.0004	0.004	E	2.10	2.64	0.083	0.104
b	0.30	0.50	0.012	0.020	E1	1.20	1.40	0.047	0.055
C	0.085	0.120	0.003	0.008	L	0.25	0.62	0.018	0.024
D	2.80	3.04	0.110	0.120	L1	0.45	0.62	0.018	0.024
e	0.95 NOM		0.0375 NOM		-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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